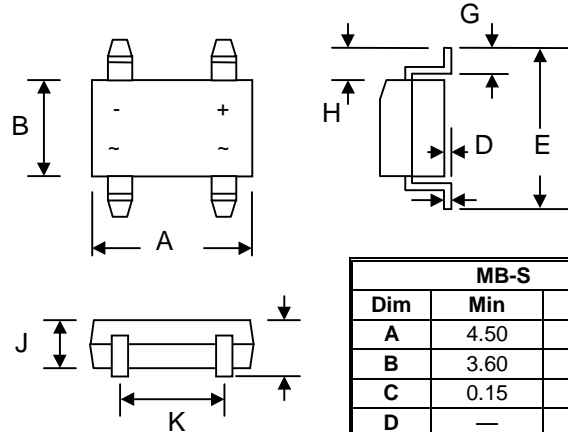


#### Features

- Schottky Barrier Chip
- Ideally Suited for Automatic Assembly
- Low Power Loss, High Efficiency
- High Surge Current Capability
- For Use in Low Voltage Application
- Plastic Case Material has UL Flammability Classification Rating 94V-O



MB-S		
Dim	Min	Max
A	4.50	4.95
B	3.60	4.10
C	0.15	0.35
D	—	0.20
E	6.40	7.00
G	0.50	1.10
H	1.30	1.70
J	2.30	2.70
K	2.30	2.70
L	—	3.00
All Dimensions in mm		

#### Mechanical Data

- Case: MB-S, Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Case
- Weight: 0.22 grams (approx.)
- Mounting Position: Any
- Marking: Type Number
- **Lead Free: For RoHS / Lead Free Version**

#### Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	KMB 12S	KMB 13S	KMB 14S	KMB 15S	KMB 16S	KMB 18S	KMB 110S	KMB 115S	KMB 120S	KMB 125S	Unit	
Peak Repetitive Reverse Voltage	$V_{RRM}$	20	30	40	50	60	80	100	150	200	250	V	
Working Peak Reverse Voltage	$V_{RWM}$												
DC Blocking Voltage	$V_R$												
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	35	42	56	70	105	140	175	V	
Average Rectified Output Current @ $T_L = 90^\circ\text{C}$	$I_O$	1.0										A	
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	30										A	
Forward Voltage @ $I_F = 1.0\text{A}$	$V_{FM}$	0.50			0.70		0.85		0.90		0.92	V	
Peak Reverse Current @ $T_A = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_A = 100^\circ\text{C}$	$I_{RM}$	0.1						20					mA
Typical Thermal Resistance (Note 1)	$R_{\theta JL}$ $R_{\theta JA}$	10					50						$^\circ\text{C/W}$
Typical Junction Capacitance	$C_j$	110					30			110			pF
Operating Temperature Range	$T_j$	-65 to +150										$^\circ\text{C}$	
Storage Temperature Range	$T_{STG}$	-65 to +150										$^\circ\text{C}$	

Note: 1. Mounted on P.C. Board with 5.0mm<sup>2</sup> copper pad area.